

K1295-VB Datasheet N-Channel 100-V (D-S) MOSFET

| PRODUCT | SUMMARY | |
|--------------------------|---------------------------------|--------------------|
| V _{(BR)DSS} (V) | r _{DS(on)} (Ω) | I _D (A) |
| 100 | 0.034 at V _{GS} = 10 V | 50 ^a |

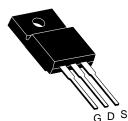
FEATURES

- Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R_g Tested

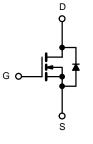
APPLICATIONS

• Isolated DC/DC Converters





TO-220 FULLPAK



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS | T _C = 25 °C, unless oth | erwise noted | | |
|--|-------------------------------------|-----------------------------------|------------------|------|
| Parameter | | Symbol | Limit | Unit |
| Drain-Source Voltage | | V _{DS} | 100 | V |
| Gate-Source Voltage | | V _{GS} | ± 20 | v |
| Continuous Drain Current (T ₁ = 175 °C) | T _C = 25 °C | 1- | 50 ^a | |
| Continuous Drain Current (1) = 175 C) | T _C = 125 °C | I _D | 28 ^a | A |
| Pulsed Drain Current | | I _{DM} | 120 | A |
| Avalanche Current | L = 0.1 mH | I _{AS} | 31 | |
| Single Pulse Avalanche Energy ^b | L = 0.11111 | E _{AS} | 61 | mJ |
| | T _C = 25 °C | р | 360 ^c | 14/ |
| Maximum Power Dissipation ^b | T _A = 25 °C ^d | – P _D – | 3.70 | W |
| Operating Junction and Storage Temperature Ra | ange | T _J , T _{stg} | - 55 to 175 | °C |

| THERMAL RESISTANCE R | ATINGS | | | |
|--------------------------|---------------------------------|-------------------|-------|------|
| Parameter | | Symbol | Limit | Unit |
| Junction-to-Ambient | PCB Mount (TO-263) ^d | R _{thJA} | 40 | °C/W |
| Junction-to-Case (Drain) | | R _{thJC} | 0.4 | C/W |

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---|----------------------|--|------|-------|-------|------|
| Static | - | | | | 1 | I |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | $V_{DS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$ | 100 | | | V |
| Gate-Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | 1.5 | | 2.5 | v |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA |
| | | $V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | 1 | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$ | | | 50 | μA |
| | | $V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 \text{ °C}$ | | | 250 | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 V$, $V_{GS} = 10 V$ | 120 | | | А |
| | | V _{GS} = 10 V, I _D = 30 A | | 0.034 | | Ω |
| Drain-Source On-State Resistance ^a | r _{DS(on)} | V_{GS} = 10 V, I _D = 30 A, T _J = 125 °C | | 0.063 | | |
| | | V_{GS} = 10 V, I _D = 30 A, T _J = 175 °C | | 0.084 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 30 A | 25 | | | S |
| Dynamic ^b | • | | | | | |
| Input Capacitance | C _{iss} | | | 5100 | | pF |
| Output Capacitance | C _{oss} | V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz | | 480 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 210 | | |
| Total Gate Charge ^c | Qg | | | 90 | 130 | |
| Gate-Source Charge ^c | Q _{gs} | V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 65 A | | 23 | | nC |
| Gate-Drain Charge ^c | Q _{gd} | | | 34 | | |
| Gate Resistance | Rg | | 0.5 | 1.7 | 3.3 | Ω |
| Turn-On Delay Time ^c | t _{d(on)} | | | 24 | 35 | |
| Rise Time ^c | t _r | V_{DD} = 100 V, R _L = 1.5 Ω | | 220 | 330 | ns |
| Turn-Off Delay Time ^c | t _{d(off)} | $\rm I_D \cong 65$ A, $\rm V_{GEN}$ = 10 V, $\rm R_g$ = 2.5 Ω | | 45 | 70 | |
| Fall Time ^c | t _f | | | 200 | 300 | |
| Source-Drain Diode Ratings and Cha | aracteristics 7 | $\Gamma_{\rm C} = 25 \ ^{\circ}{\rm C}^{\rm b}$ | | | | |
| Continuous Current | ا _S | | | 50 | | ٨ |
| Pulsed Current | I _{SM} | | | 120 | | A |
| Forward Voltage ^a | V _{SD} | $I_{F} = 65 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$ | | 1.0 | 1.5 | V |
| Reverse Recovery Time | t _{rr} | | | 130 | 200 | ns |
| Peak Reverse Recovery Current | I _{RM(REC)} | I _F = 50 A, di/dt = 100 A/µs | | 8 | 12 | А |
| Reverse Recovery Charge | Q _{rr} | | | 0.52 | 1.2 | μC |

Notes:

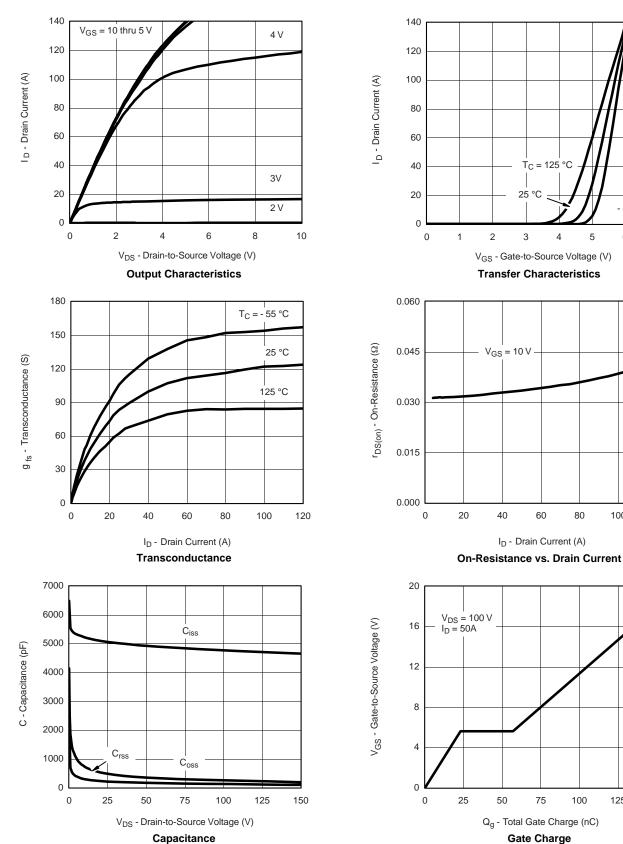
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing. c. Independent of operating temperature.

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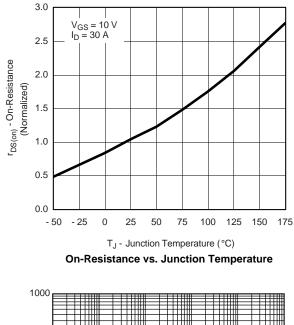
- 55 °C

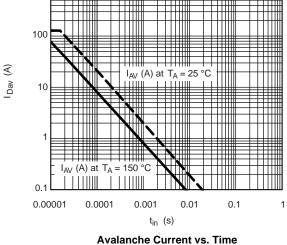


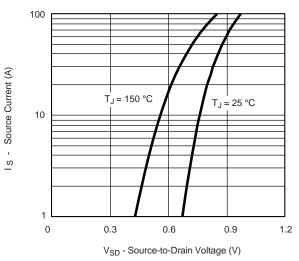
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



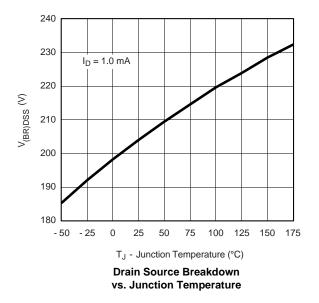
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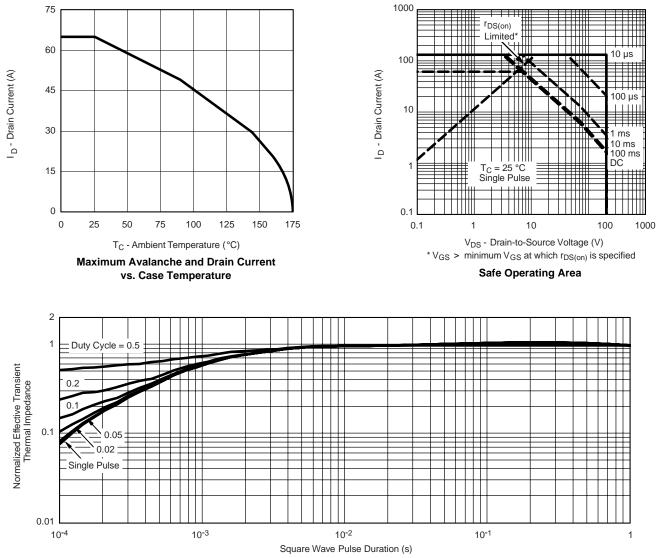


Source-Drain Diode Forward Voltage





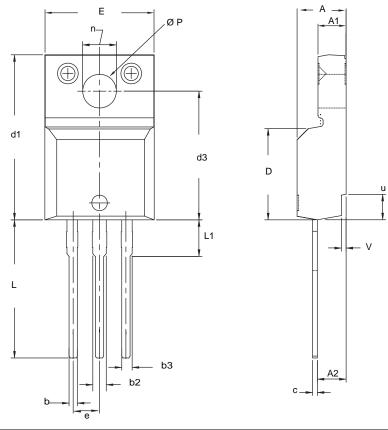
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-220 FULLPAK (HIGH VOLTAGE)



| DIM. | MILLI | METERS | INC | HES |
|------|--------|--------|-----------|-------|
| | MIN. | MAX. | MIN. | MAX. |
| А | 4.570 | 4.830 | 0.180 | 0.190 |
| A1 | 2.570 | 2.830 | 0.101 | 0.111 |
| A2 | 2.510 | 2.850 | 0.099 | 0.112 |
| b | 0.622 | 0.890 | 0.024 | 0.035 |
| b2 | 1.229 | 1.400 | 0.048 | 0.055 |
| b3 | 1.229 | 1.400 | 0.048 | 0.055 |
| С | 0.440 | 0.629 | 0.017 | 0.025 |
| D | 8.650 | 9.800 | 0.341 | 0.386 |
| d1 | 15.88 | 16.120 | 0.622 | 0.635 |
| d3 | 12.300 | 12.920 | 0.484 | 0.509 |
| E | 10.360 | 10.630 | 0.408 | 0.419 |
| е | 2.54 | BSC | 0.100 BSC | |
| L | 13.200 | 13.730 | 0.520 | 0.541 |
| L1 | 3.100 | 3.500 | 0.122 | 0.138 |
| n | 6.050 | 6.150 | 0.238 | 0.242 |
| ØP | 3.050 | 3.450 | 0.120 | 0.136 |
| u | 2.400 | 2.500 | 0.094 | 0.098 |
| V | 0.400 | 0.500 | 0.016 | 0.020 |

Notes

1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet $C_{pk} > 1.33$. 4. All dimensions include burrs and plating thickness. 5. No chipping or package damage.



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